**Product data sheet** 

# 1. Product profile

## 1.1 General description

Ultrafast, dual common cathode, epitaxial rectifier diode in a SOT78 (TO-220AB) plastic package.

### 1.2 Features

- Fast switching
- Soft recovery characteristic
- Low switching loss

- Low thermal resistance
- Low forward voltage drop
- High thermal cycling performance

## 1.3 Applications

- Output rectifiers in high frequency switched-mode power supplies
- Discontinuous Current Mode (DCM)
  Power Factor Correction (PFC)

#### 1.4 Quick reference data

- $V_{RRM} \le 600 \text{ V}$
- V<sub>F</sub> ≤ 1.16 V

- $I_{O(AV)} \le 20 \text{ A}$
- $t_{rr} \le 60 \text{ ns}$

# 2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	anode 1		
2	cathode	mb	1
3	anode 2	705	
3 mb	mounting base; cathode		sym084
		SOT78 (3-lead TO-220)	AB)

**Dual rectifier diode ultrafast** 

# 3. Ordering information

#### Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
BYV34-600	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

# 4. Limiting values

### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

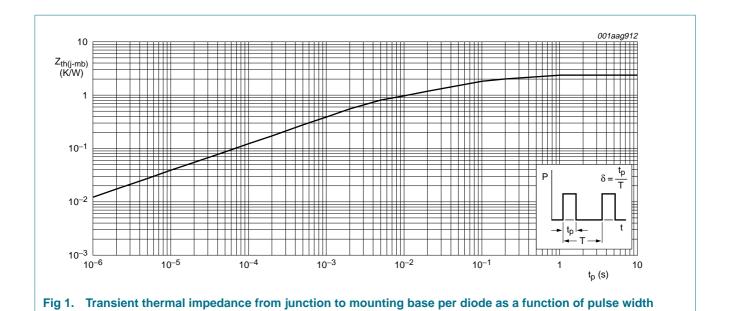
		,			
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	600	V
$V_{RWM}$	crest working reverse voltage		-	600	V
$V_R$	reverse voltage	square waveform; $\delta$ = 1.0; $T_{mb} \le 138  ^{\circ}C$	-	600	V
I <sub>O(AV)</sub>	average output current	square waveform; $\delta$ = 0.5; $T_{mb} \le 107$ °C; both diodes conducting	-	20	Α
I <sub>FRM</sub>	repetitive peak forward current	$t$ = 25 $\mu$ s; square waveform; $\delta$ = 0.5; $T_{mb} \le$ 107 °C; per diode	-	20	Α
I <sub>FSM</sub>	non-repetitive peak forward current	t = 10 ms; sinusoidal waveform; per diode	-	120	Α
		t = 8.3 ms; sinusoidal waveform; per diode	-	132	Α
T <sub>stg</sub>	storage temperature		-40	+150	°C
Tj	junction temperature		-	150	°C

# 5. Thermal characteristics

#### Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	with heatsink compound; per diode; see Figure 1	-	-	2.4	K/W
		with heatsink compound; both diodes conducting	-	-	1.6	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W

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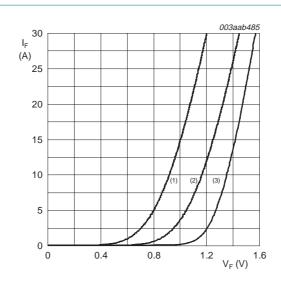
### 6. Characteristics

#### Table 5. Characteristics

 $T_i = 25 \,^{\circ}C$  unless otherwise specified.

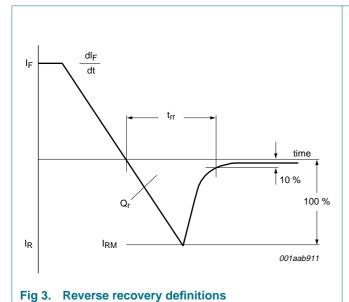
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V <sub>F</sub>	forward voltage	$I_F = 10 \text{ A}$ ; $T_j = 150 ^{\circ}\text{C}$ ; see Figure 2	-	0.92	1.16	V
		I <sub>F</sub> = 20 A; see <u>Figure 2</u>	-	1.07	1.48	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V	-	10	50	μΑ
		$V_R = 600 \text{ V}; T_j = 100 ^{\circ}\text{C}$	-	0.2	0.6	mA
Dynamic cl	haracteristics					
Q <sub>r</sub>	recovered charge	$I_F$ = 2 A to $V_R$ $\geq$ 30 V; $dI_F/dt$ = 20 A/ $\mu$ s; see Figure 3	-	40	70	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A to V}_R \ge 30 \text{ V};$ $dI_F/dt = 100 \text{ A/}\mu\text{s}; \text{ see } \underline{\text{Figure 3}}$	-	50	60	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F$ = 10 A to $V_R$ $\geq$ 30 V; $dI_F/dt$ = 50 A/ $\mu$ s; $T_j$ = 100 °C; see Figure 3	-	3	5	Α
V <sub>FR</sub>	forward recovery voltage	$I_F = 10 \text{ A}$ ; $dI_F/dt = 10 \text{ A}/\mu\text{s}$ ; see Figure 4	-	3.2	-	V

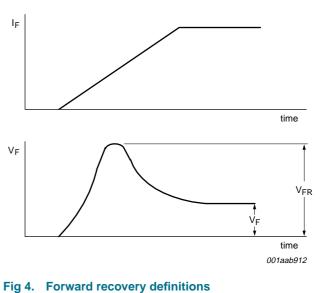
#### **Dual rectifier diode ultrafast**



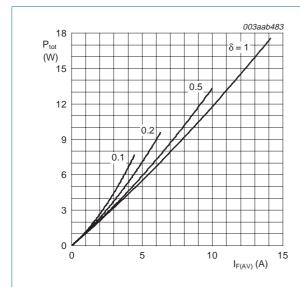
- (1)  $T_j = 150 \,^{\circ}\text{C}$ ; typical values
- (2)  $T_j = 150 \,^{\circ}\text{C}$ ; maximum values
- (3)  $T_j = 25$  °C; maximum values

Fig 2. Forward current as a function of forward voltage



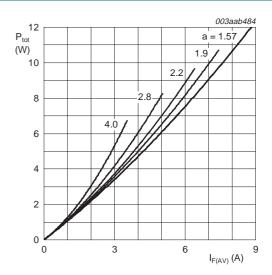


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 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ 

Fig 5. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode



 $a = form factor = I_{F(RMS)} / I_{F(AV)}$ 

Fig 6. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values; per diode

# 7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78

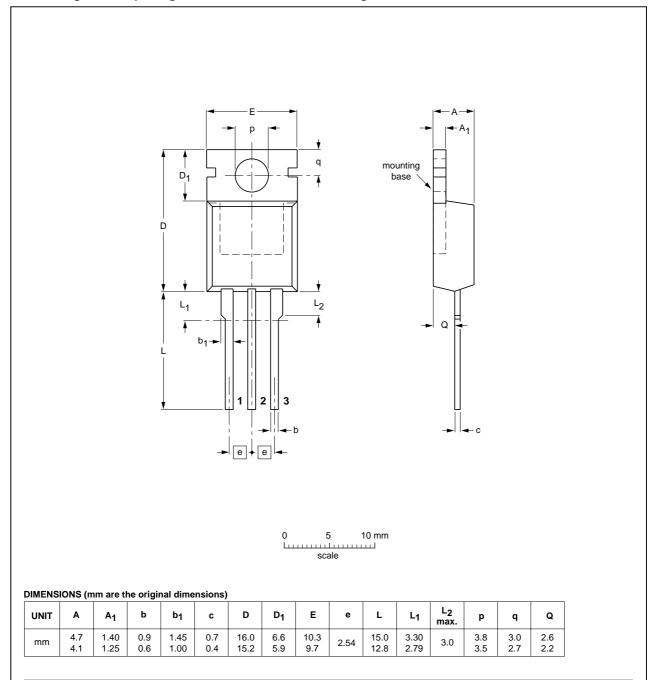


Fig 7. Package outline SOT78 (3-lead TO-220AB)

**JEITA** 

SC-46

REFERENCES

**JEDEC** 

3-lead TO-220AB

**ISSUE DATE** 

05-03-22

**EUROPEAN** 

**PROJECTION** 

OUTLINE

VERSION

SOT78

### Dual rectifier diode ultrafast

# 8. Revision history

### Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BYV34-600 V.2	20180928	Product data sheet	-	BYV34-600_1
Modification:	Change from NXP ve	ersion to WeEn Version		
BYV34-600_1	20071004	Product data sheet	-	-

#### **Dual rectifier diode ultrafast**

# 9. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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